



Product Change Notification

Change Notification #: 115802 - 01
Change Title: Select Intel® SSD DC P4510 Series Products, PCN 115802-01, Product Material, PCB Marking Change
Reason for Revision: Corrected Marketing Names due to Marketing Names switched with MM#'s
Date of Publication: September 25, 2017

Key Characteristics of the Change:

Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	October 11, 2017
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Description of Change to the Customer:

The Intel® SSD DC P4510 Series SKUs listed in the Products Affected Table below will have the following change:

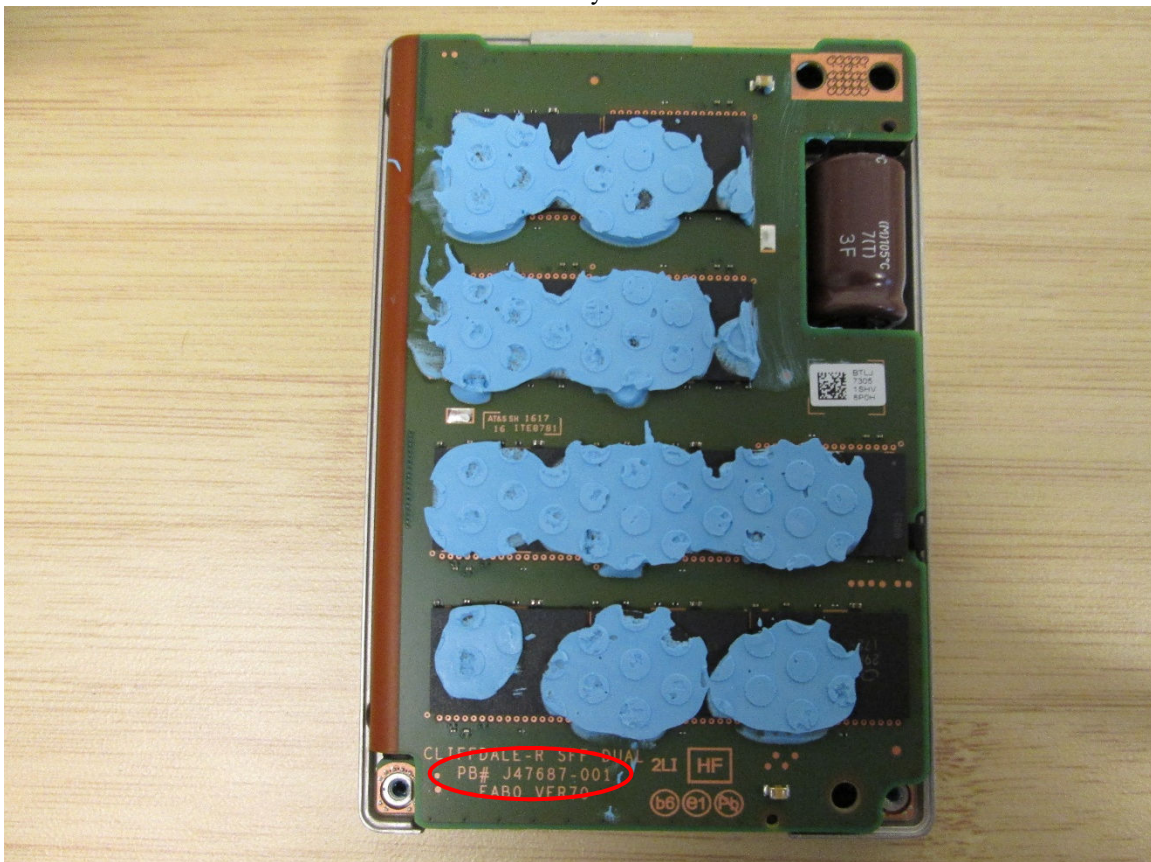
- Addition of new raw material supplier for our rigid flex PCB. PCB J68335-001 will be the primary PCB and the existing PCB J47687-001 will be secondary

Please refer to product images for changes.

Primary PCB:



Secondary PCB:



Customer Impact of Change and Recommended Action:

Intel anticipates no functional impact to customers but encourages customer to understand the changes and determine the impact to their operations if any.

There is the possibility of Intel shipping mixed inventory.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Representative if you have any further questions about these changes.

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Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#
Intel® SSD DC P4510 Series (2.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPE2KX020T801	959393
Intel® SSD DC P4510 Series (2.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDPE2KX020T810	959394

PCN Revision History:

Date of Revision:

September 13, 2017

September 25, 2017

Revision Number:

00

01

Reason:

Originally Published PCN

Corrected Marketing Names due to Marketing Names switched with MM#'s



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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